





DMC3028LSD

30V COMPLEMENTARY DUAL ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(on)}	I _D T _A = 25°C
Q1	30V	28mΩ @ V _{GS} = 10V 7.1	
QI	30 V	45mΩ @ V _{GS} = 4.5V	5.6A
02	201/	25mΩ @ V _{GS} = -10V	-7.4A
Q2	-30V	41mΩ @ V _{GS} = -4.5V	-5.7A

Description and Applications

This new generation complementary dual MOSFET features low onresistance and fast switching, making it ideal for high efficiency power management applications.

- Motor control
- Backlighting
- DC-DC Converters
- · Power management functions

Features and Benefits

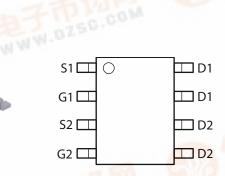
- Low on-resistance
- · Fast switching speed
- "Green" Component and RoHS Compliant (Note 1)

Mechanical Data

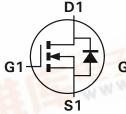
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)



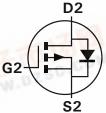
TOP VIEW



Top view



Q1 N-Channel



Q2 P-Channel

Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel	
DMC3028LSD-13	C3028LD	13	12	2,500	

Note:

1. Diodes, Inc. defines "Green" products as those which are Eu RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website

Marking Information



Oll = Manufacturer's Marking C3028LD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 09 = 2009) WW = Week (01-52)





DMC3028LSD

Maximum Ratings @T_A = 25°C unless otherwise specified

	Symbol	N-Channel - Q1	P-Channel - Q2	Units		
Drain-Source Voltage	V _{DSS}	30	-30	V		
Gate-Source Voltage			V _{GSS}	±20	±20	V
	V _{GS} = 10V	(Notes 3 & 5)	I _D	7.1	-7.4	A
Continuous Drain Current		$T_A = 70^{\circ}C \text{ (Notes 3 \& 5)}$		5.7	-5.9	
Continuous Diain Current		(Notes 2 & 5)		5.5	-5.8	A
		(Notes 2 & 6)		6.6	-6.8	
Pulsed Drain Current V _{GS} = 10V (Notes 4 & 5)		(Notes 4 & 5)	I _{DM}	34	-36	Α
Continuous Source Current (Body diode) (No		(Notes 3 & 5)	I _S	3.5	-3.5	А
Pulsed Source Current (Body diode) (Notes 4 & 5)		I _{SM}	34	-36	Α	

Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	N-Channel - Q1	Unit		
Power Dissipation Linear Derating Factor	(Notes 2 & 5)	P _D		1.3 W 10 mW/°		
Power Dissipation Linear Derating Factor	(Notes 2 & 6)	P _D	1. 1	W mW/°C		
Power Dissipation Linear Derating Factor	(Notes 3 & 5)	P _D	2.	W mW/°C		
Thermal Resistance, Junction to Ambient	(Notes 2 & 5) (Notes 2 & 6) (Notes 3 & 5)	$R_{\theta JA}$	10 7 6	°C/W		
Thermal Resistance, Junction to Lead	(Notes 5 & 7)	$R_{\theta JL}$	51 46		°C/W	
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to	°C			

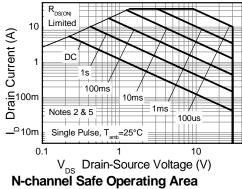
Notes:

- 2. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

 3. Same as note (2), except the device is measured at t ≤ 10 sec.
- 4. Same as note (2), except the device is pulsed with D= 0.02 and pulse width 300 µs. The pulse current is limited by the maximum junction temperature.
- 5. For a dual device with one active die.
- 6. For a device with two active die running at equal power.
- 7. Thermal resistance from junction to solder-point (at the end of the drain lead).

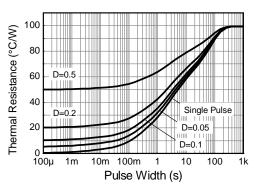


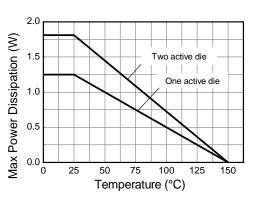
DMC3028LSD



R_{DS(ON)} Limited Drain Current (A) Notes 2 & 5 100us Single Pulse, T_{amb}=25°C = -V_{DS} Drain-Source Voltage (V)

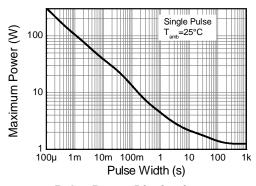
P-channel Safe Operating Area





Transient Thermal Impedance

Derating Curve



Pulse Power Dissipation



Electrical Characteristics – Q1 N-Channel @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μА	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	1.0		3.0	V	$I_D=250\mu A,\ V_{DS}=V_{GS}$
Static Drain-Source On-Resistance (Note 8)	D			0.028	Ω	V _{GS} = 10V, I _D = 6.0A
Static Dialit-Source Off-Nesistance (Note 6)	R _{DS (ON)}			0.045	22	V _{GS} = 4.5V, I _D = 4.9A
Forward Transconductance (Notes 8 & 9)	g fs		12	_	S	V _{DS} = 15V, I _D = 6.0A
Diode Forward Voltage (Note 8)	V _{SD}	_	0.68	1.2	V	I _S = 1.7A, V _{GS} = 0V
Reverse recovery time (Note 9)	t _{rr}		11.5	_	ns	1 4 74 4:/44 4004/ -
Reverse recovery charge (Note 9)	Qrr	_	4.4	_	nC	I _S = 1.7A, di/dt= 100A/μs
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	472	_	pF	
Output Capacitance	Coss	_	178	_	pF	V _{DS} = 15V, V _{GS} = 0V -f= 1MHz
Reverse Transfer Capacitance	C _{rss}	_	65	_	pF	1- 1101112
Total Gate Charge	Qg		5.2	_	nC	V _{DS} = 15V, V _{GS} = 4.5V I _D = 6A
Total Gate Charge	Q_g	_	10.5	_	nC	
Gate-Source Charge	Q _{gs}	_	1.86	_	nC	V _{DS} = 15V, V _{GS} = 10V
Gate-Drain Charge	Q _{gd}	_	2.3	_	nC	-I _D = 6A
Turn-On Delay Time (Note 10)	t _{D(on)}	_	2.5	_	ns	
Turn-On Rise Time (Note 10)	t _r	_	3.1		ns	V _{DD} = 15V, V _{GS} = 10V
Turn-Off Delay Time (Note 10)	t _{D(off)}	_	14	_	ns	$I_D=1A, R_G \cong 6.0\Omega$
Turn-Off Fall Time (Note 10)	t _f		9.7	_	ns	

Notes:

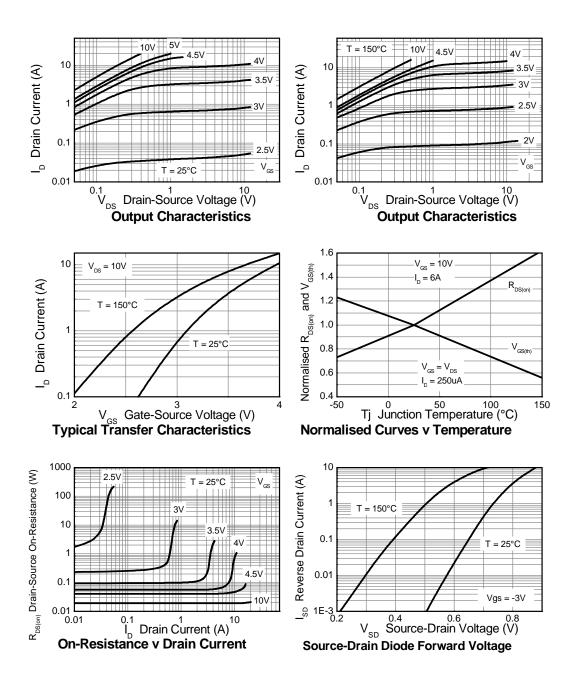
^{8.} Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$

^{9.} For design aid only, not subject to production testing.

10. Switching characteristics are independent of operating junction temperatures.

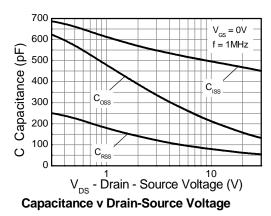


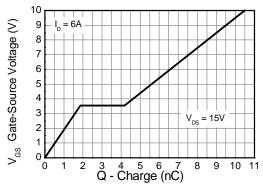
Q1 N-Channel





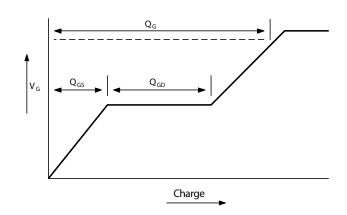
Q1 N-Channel continued





Gate-Source Voltage v Gate Charge

Test Circuits - Q1 N-Channel



Current regulator

12V 0.2µF 50k Same as D.U.T

V_{DS}

V_{SS}

D.U.T

Gate charge test circuit

Basic gate charge waveform

OV_{os}

Switching time waveforms

Switching time test circuit

V_{DS} 90%

10%



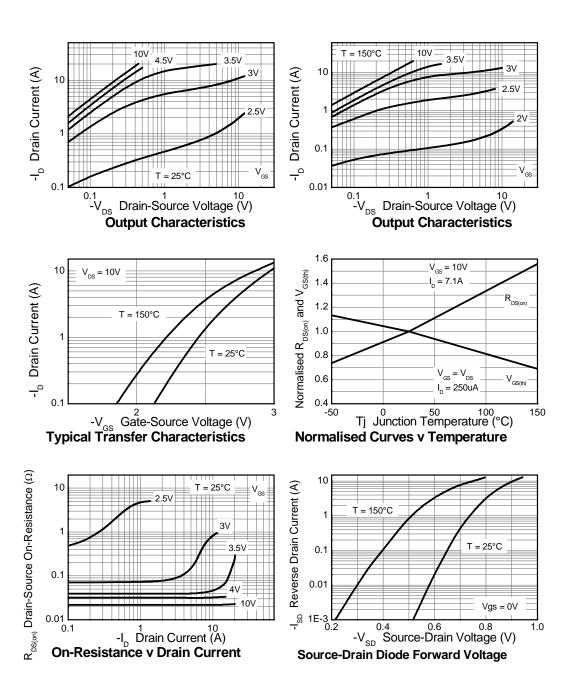
Electrical Characteristics – Q2 P-Channel @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS				•	•	
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$I_D = -250 \mu A, V_{GS} = 0 V$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-0.5	μА	V _{DS} = -30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	-1.0		-3.0	V	I_{D} = -250 μ A, V_{DS} = V_{GS}
Static Drain-Source On-Resistance (Note 8)	Б			0.025	Ω	V _{GS} = -10V, I _D = -7.1A
Static Dialif-Source Off-Resistance (Note 6)	R _{DS (ON)}	_	_	0.041	22	V _{GS} = -4.5V, I _D = -5.5A
Forward Transconductance (Notes 8 & 9)	g fs	_	18.6	_	S	V _{DS} = -15V, I _D = -7.1A
Diode Forward Voltage (Note 8)	V_{SD}	_	-0.80	-1.2	V	I _S = -1.7A, V _{GS} = 0V
Reverse recovery time (Note 9)	t _{rr}		16.2	_	ns	1 0 00 4:/4+ 4000/ -
Reverse recovery charge (Note 9)	Q _{rr}	_	10	_	nC	I _S = -2.2A, di/dt= 100A/μs
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	1678	_	pF	
Output Capacitance	Coss	_	303	_	pF	V _{DS} = -15V, V _{GS} = 0V -f= 1MHz
Reverse Transfer Capacitance	C _{rss}	_	178	_	pF	1- 1101112
Total Gate Charge	Qg	_	16.4	_	nC	V _{DS} = -15V, V _{GS} = -4.5V I _D = -7.1A
Total Gate Charge	Qg	_	31.6	_	nC	
Gate-Source Charge	Q _{gs}	_	4.3	_	nC	V _{DS} = -15V, V _{GS} = -10V -I _D = -7.1A
Gate-Drain Charge	Q _{gd}	_	6.2	_	nC	- ID= -7.1A
Turn-On Delay Time (Note 10)	t _{D(on)}	_	3.5	_	ns	
Turn-On Rise Time (Note 10)	t _r	_	4.9	_	ns	V _{DD} = -15V, V _{GS} = -10V
Turn-Off Delay Time (Note 10)	t _{D(off)}	_	44		ns	I_D = -1A, $R_G \cong 6.0\Omega$
Turn-Off Fall Time (Note 10)	t _f		28		ns	<u>] </u>

- 8. Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2\%$
- For design aid only, not subject to production testing.
 Switching characteristics are independent of operating junction temperatures.

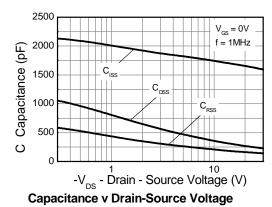


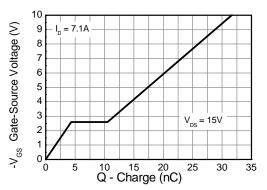
Q2 P-Channel





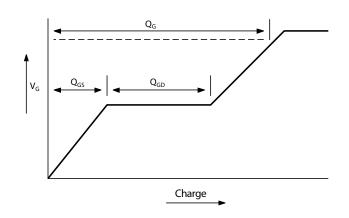
Q2 P-Channel continued

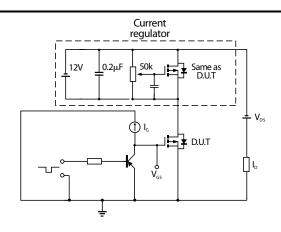




Gate-Source Voltage v Gate Charge

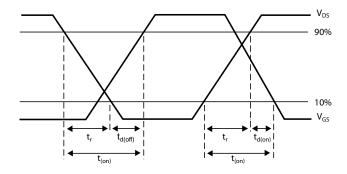
Test Circuits - Q2 P-Channel

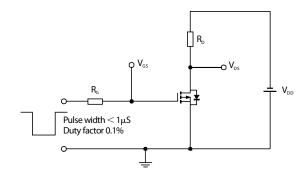




Basic gate charge waveform

Gate charge test circuit



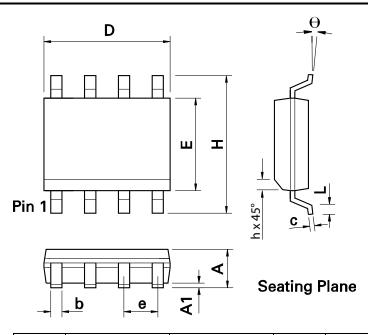


Switching time waveforms

Switching time test circuit

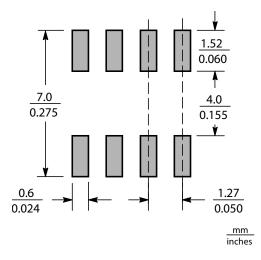


Package Outline Dimensions



DIM	Inc	hes	Millin	Millimeters DIM		Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
Α	0.053	0.069	1.35	1.75	е	0.050 BSC		1.27 BSC	
A1	0.004	0.010	0.10	0.25	b	0.013 0.020		0.33	0.51
D	0.189	0.197	4.80	5.00	С	0.008	0.010	0.19	0.25
Н	0.228	0.244	5.80	6.20	θ	0°	8°	0°	8°
Е	0.150	0.157	3.80	4.00	h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27	-	-	-	-	-

Suggested Pad Layout







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